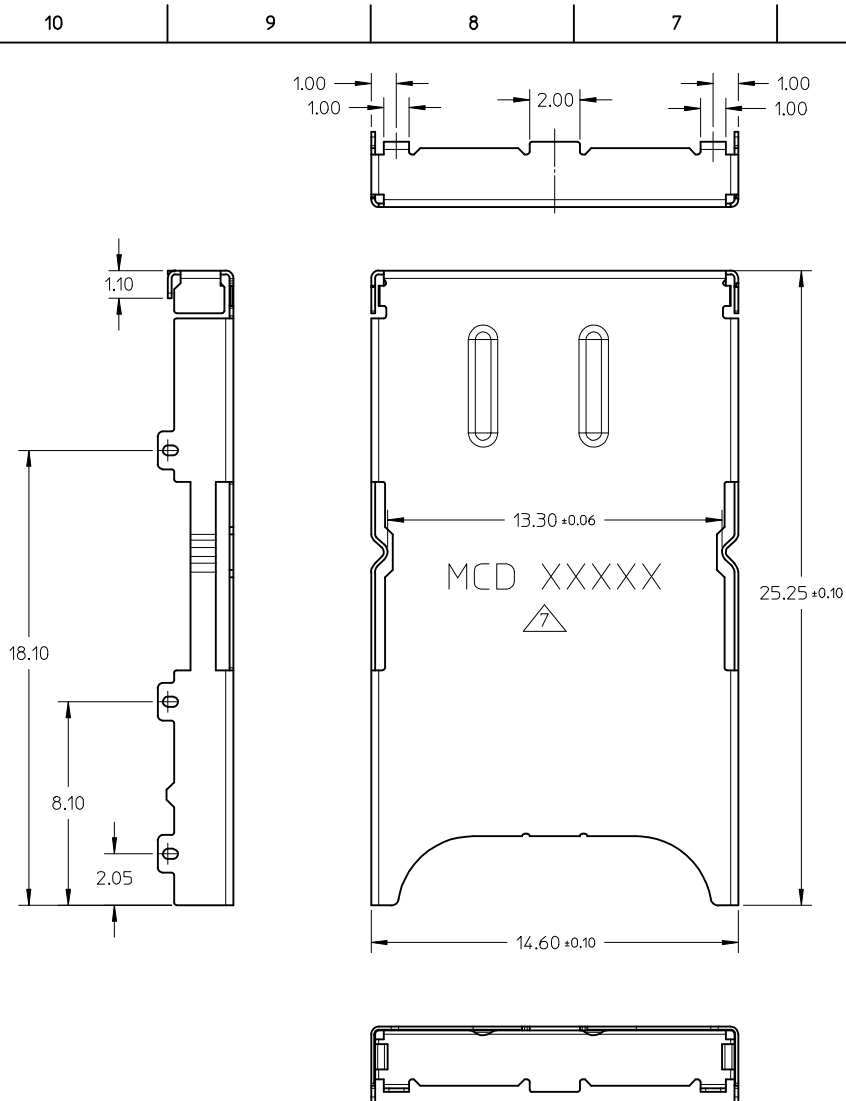
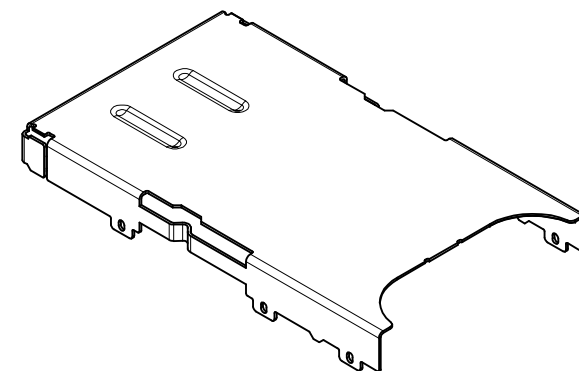




NOTES:

1. MATERIALS: STAINLESS STEEL, T=0.15MM;
2. FINISHES:
1.27μM MIN. NICKEL UNDERPLATING OVERALL;
0.05μM MIN. GOLD PLATING ON SOLDERING AREA;
3. PRODUCT SPECIFICATION: PS-151130-0101;
4. PACKAGING SPECIFICATION: PK-151130-0101;
5. SOLDER TAIL COPLANARITY: 0.10MM MAX;
6. THIS PART IS A FRAME ONLY. IT SHOULD BE USED TOGETHER WITH
1.40MM HEIGHT MICRO SD CONNECTOR 151029 AND 0.38MM BLOCK
SIM CONNECTOR 151130 FOR AN ENTIRE 3 IN 3 SYSTEM;

7. DATE CODE PRINTED: MCD XX XX X;
DAY: 1 ~ 7
WEEK: 1 ~ 52
YEAR: 14, 15, 16, ...



PART DESCRIPTION	
1511300101	1511300111

DRAWING REVISE
EC NO: S2016-0060
DRWN:HLWANG06
CHKD:JZENG
APPR:KHLIM

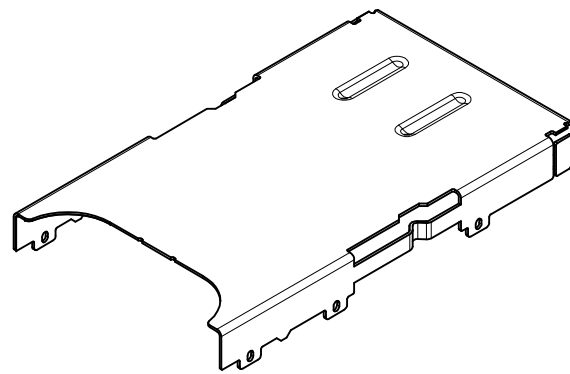
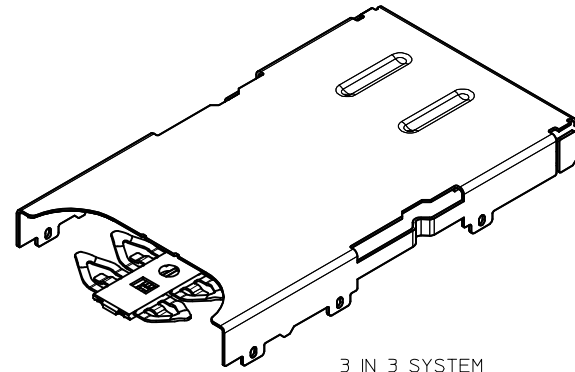
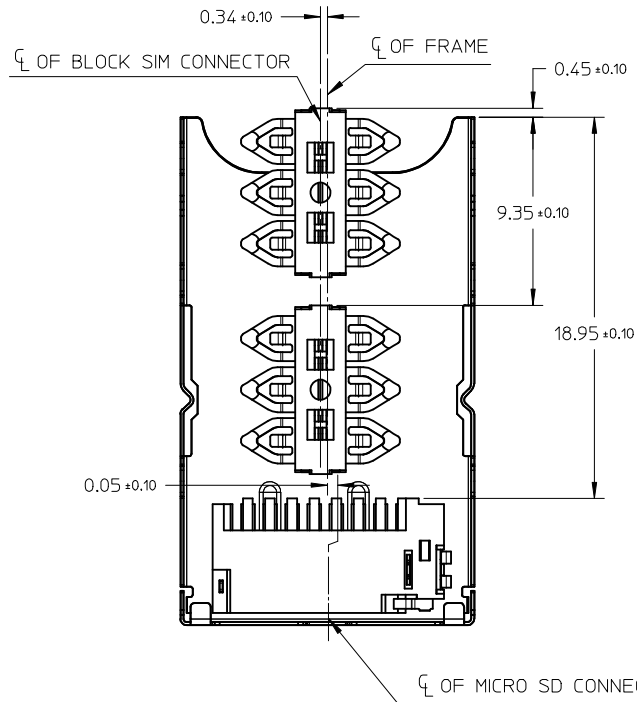
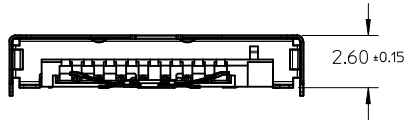
QUALITY SYMBOLS
F_A=0
F_B=0
F_C=0

GENERAL TOLERANCES (UNLESS SPECIFIED)		
	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± 0.13	± ---
1 PLACE	± 0.20	± ---
0 PLACE	± ---	± ---
ANGULAR ± 3 °		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		

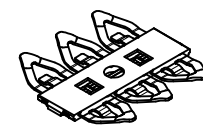
DIMENSION STYLE MM ONLY	
DRAWN BY	DATE
HLWANG06	2014/11/25
CHECKED BY	DATE
JZENG	2014/12/22
APPROVED BY	DATE
KHLIM	2015/08/06
MATERIAL NO.	
SEE TABLE	

SCALE NTS	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
SALES DRAWING FOR 2.60MM HEIGHT 3 IN 3 FRAME		
molex		
DOCUMENT NO.		SHEET NO.
SD-151130-0101		1 OF 3

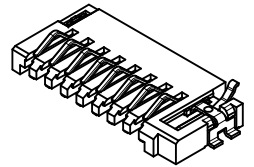
3 IN 3 SIM SYSTEM
(WITH MICRO SD CONNECTOR & BLOCK SIM CONNECTOR)



PART 1:
FRAME
1511300101



PART 2:
BLOCK SIM CONNECTOR
1511300001



PART 3:
MICRO SD CONNECTOR
1511290001

DRAWING REVISE EC NO: S2016-0060 DRWN:HLWANG06 CHKD: ZENG APPR:KHLIM	2015/07/10 2015/08/05 2015/08/06	DESCRIPTION	QUALITY SYMBOLS F_A=0 F_C=0 F_P=0	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE NTS	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
					mm	INCH	DRAWN BY HLWANG06	DATE 2014/11/25	SALES DRAWING FOR 2.60MM HEIGHT 3 IN 3 FRAME molex			
				4 PLACES	± ---	± ---	CHECKED BY	DATE				
				3 PLACES	± ---	± ---	JZENG	2014/12/22				
				2 PLACES	± 0.13	± ---	APPROVED BY	DATE	SD-151130-0101			
				1 PLACE	± 0.20	± ---	KHLIM	2015/08/06				
				0 PLACE	± ---	± ---	MATERIAL NO.					DOCUMENT NO.
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SEE TABLE		2 OF 3			
5	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION										

10 9 8 7 6 5 4 3 2 1

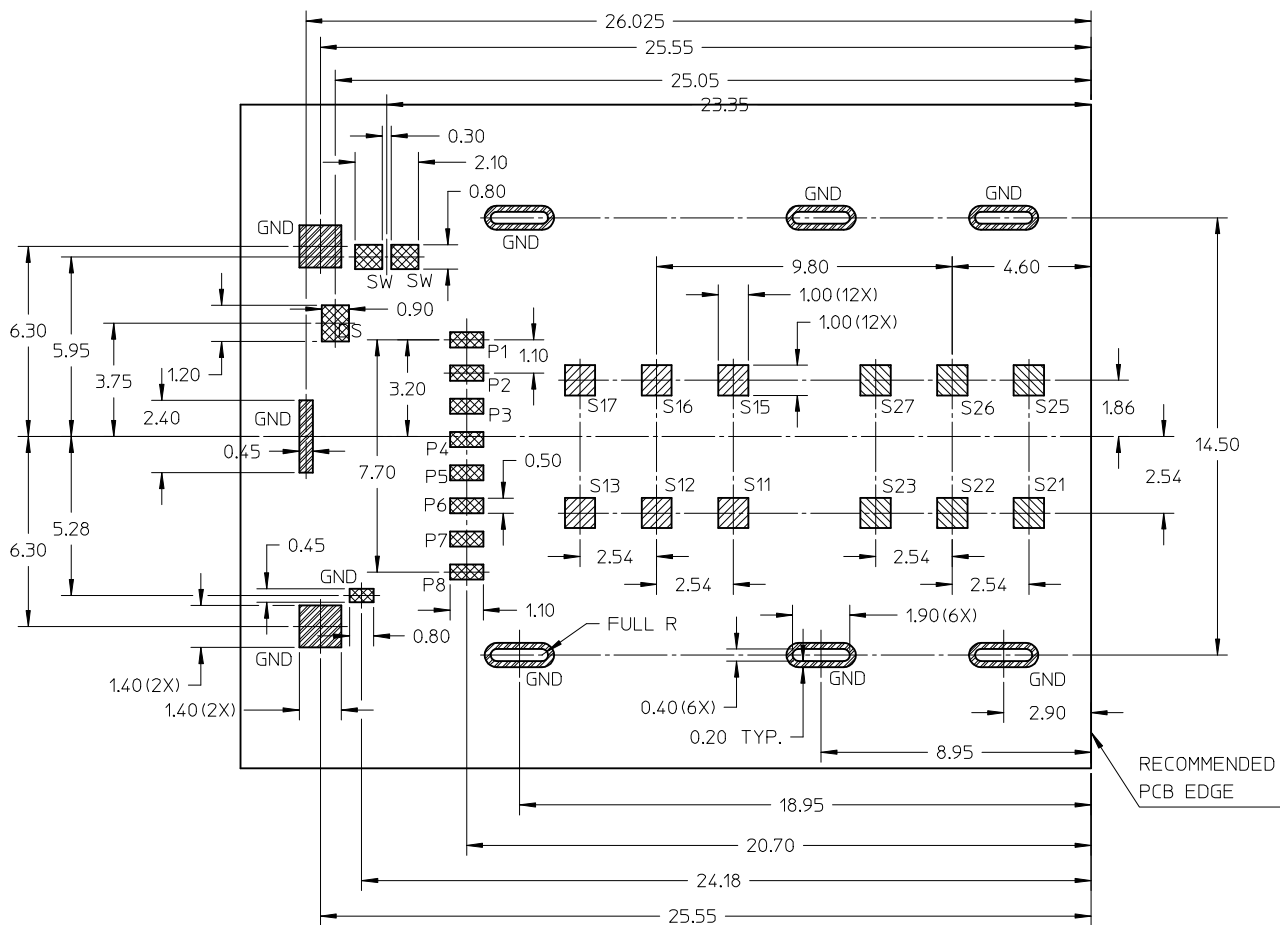
BLCOK SIM CONNECTOR 1 SOLDERING AREA: 

BLCOK SIM CONNECTOR 2 SOLDERING AREA: 

MICRO SD CONNECTOR SOLDERING AREA: 

FRAME SOLDERING AREA: 

PIN ASSIGNMENT:
S11 ~ S17: NANO SIM #1 PIN 1 ~ PIN 7;
S21 ~ S27: NANO SIM #2 PIN 1 ~ PIN 7;
P1 ~ P7: MICRO SD PIN 1 ~ PIN 8;
DS: DETECT SPRING;
SW: SWITCH;
GND: GROUND



RECOMMENDED PCB LAYOUT
THICKNESS: 0.45±0.05MM
TOLERANCE: ±0.05MM

DRAWING REVISE			DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
EC NO: S2016-0060								MM ONLY		NTS	METRIC		
2015/07/10					mm INCH			DRAWN BY DATE		TITLE			
2015/08/05					4 PLACES ± --- ± ---			HLWANG06 2014/11/25					
2015/08/05					3 PLACES ± --- ± ---			CHECKED BY DATE					
2015/08/06					2 PLACES ± 0.13 ± ---			JZENG 2014/12/22					
					1 PLACE ± 0.20 ± ---			APPROVED BY DATE					
2015/08/06			0 PLACE ± --- ± ---			KHLIM 2015/08/06		SALES DRAWING FOR 2.60MM HEIGHT 3 IN 3 FRAME					
			ANGULAR ± 3 °			MATERIAL NO.						DOCUMENT NO.	
			DRAFT WHERE APPLICABLE			SEE TABLE		SD-151130-0101				3 OF 3	
			MUST REMAIN WITHIN DIMENSIONS			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							